



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Chopra et al.

**Serial No.:** 10/620,002

**Filed:** July 14, 2003

**For:** SLURRY FOR USE WITH FIXED-  
ABRASIVE POLISHING PADS IN  
POLISHING SEMICONDUCTOR DEVICE  
CONDUCTIVE STRUCTURES THAT  
INCLUDE COPPER AND TUNGSTEN

**Confirmation No.:** 7481

**Examiner:** L. Umez-Eronini

**Group Art Unit:** 1765

**Attorney Docket No.:** 2269-4373.2US  
(00-0036.02/US)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

October 23, 2006  
Date

Signature

Erika Gandre  
Name (Type/Print)

Do Not Enter  
Amendment

L. J. U-E,

11/16/2006

**RESPONSE TO FINAL OFFICE ACTION**

Mail Stop Amendment  
Commissioner for Patents  
PO Box 1450  
Alexandria, VA 22313-1450

Sir:

This Response follows the final Office Action of August 21, 2006, the shortened statutory period for response to which expires on November 21, 2006. This Response is being submitted within two months of the mailing date of the Final Office Action.